Shuttle

PRODUCT SPECIFICATIONS

BAREBONE **XPC** slim XH510G

FLEXIBLE 3-LITRE PC WITH PCIE SLOT

The Shuttle XPC slim Barebone XH510G is a 3-litre PC to house one single-slot PCI-Express expansion cards. Together with an LGA 1200 Intel Core desktop processor of the Intel Core Gen 10/11 range, this platform is perfectly suited for many professional applications where performance, flexibility and a compact form factor matter. This includes video wall presentations, graphics workstations, media capturing, surveillance, POS, POI as well as network and industrial applications. Even mid-range gaming is possible.

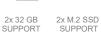








HDMI & 4K UHD DisplayPort



2.5" HDD/SSD SUPPORT



HEATPIPE COOLING







24/7 SUPPORT

SLIM DESIGN

■ Robust 3.9-litre steel chassis, black ■ Dimensions: 250 x 200 x 7.85 mm (LWH) ■ Including VESA mount (75/100 mm) ■ Supports 24/7 Nonstop Operation
Operating temperature: 0~50 °C (non-condensing)

OPERATING SYSTEM

- An operating system is not included
- Supports Windows 10, Windows 11 and Linux (64-bit)

PROCESSOR SUPPORT & CHIPSET

Socket LGA1200 supports 10th-and 11th Gen Intel Core i9/i7/i5/i3, Pentium Gold und Celeron processors, codenamed "Comet Lake-S" and "Rocket Lake-S", max. 65W TDP ■ Includes heatpipe cooling system with two fans

Intel H510 Chipset

PCIe SI OT

■ 1x PCI Express X16 v4.0/v3.0 slot ■ Supports single-slot expansion cards with max. 208 x 120 x 30 mm in size and max. 75 W TDP ■ 5V auxiliary voltage (max. 2 A) with 4-pin Molex connector

MEMORY SUPPORT

■ 2x 260-pin S0-DIMM slot ■ Supports DDR4-3200/2933/2666 ■ max. 2x 32 GB

STORAGE - SATA / M.2

- 1x 2.5" bay for SATA hard disk or SSD, max. 9.5 mm
- 2x M.2-2280M slot for SSD cards
- (both support SATA, one supports PCIe x4 NVMe)
- 1x M.2-2230E for an optional WLAN card

CONNECTORS

OPTIONAL

- HDMI 2.0a/1.4b DisplayPort 1.4 4x USB 3.2 Gen1 4x USB 2.0
- 1x USB 2.0 (4-pin onboard header 2x audio (line out, mic)
- Intel Gigabit LAN (RJ45) Connector for external power button
- "Always-On" jumper DC input

POWER SUPPLY

External 180 W / 19.5 V power adapter

OPTIONAL ACCESSORIES

■ WLAN Module (WLN-M, WLN-M1) ■ RS232 COM port (PCP11) ■ D-Sub VGA port (PVG01) ■ Cable for external power button (CXP01)



Note: Some features market in red color are only supported in combination with Gen 11 "Rocket Lake-S" processors.

MODELS OF THE XH510G SERIES

Product	Dimensions	PCIe Slots	Vertical Stand	2 nd Power Adapter	UPC Code
XH510G	250 x 200 x 78.5 mm (3.9 L)	Single (PCIe X16)	Optional (PS01)	_	887993005041
XH510G2	250 x 200 x 95 mm (4.75L)	Dual (PCIe X16 + X1)	-	Opt. (PRC01+PE180)	887993004198



PRODUCT FEATURES



Only 7.85 cm tall







The slim chassis - a clean and modern look

Shuttle has always placed great emphasis on the interior and exterior aesthetics of their Mini-PCs with the belief that a good blend of style and form factor allows the Mini-PC to be attractive, versatile and work well in almost any environment. The XH510G was designed just like that and shines in a clean and modern appearance. The front panel connectors are easy to access for daily use, and this tiny tot barely stands at 7.85 cm in height.

VESA mount included

With the supplied VESA mount you can easily attach the XH510G to the backside of an appropriate display, to a VESA arm or just to the wall. It is compatible with 75x75 mm and 100×100 mm VESA standards.

Supports 10/11th Generation Intel® Core[™] processors "Comet Lake-S" and "Rocket Lake-S" are the codenames for Intel's 10th and 11th Generation of Intel® Core[™] Desktop Processors for socket LGA1200 in combination with the 500-Series chipsets. Corresponding processors feature up to 10 cores and 20 threads and 20 MB of cache memory. With an optimal balance of frequency, cores and threads, these processors help supercharge Shuttle XPCs for maximum productivity in professional and mainstream applications.

Low noise thanks to heatpipe cooling system

An active dual-fan heatpipe cooling system ensures whisper-quiet operation and system stability. A heatpipe is a hollow tube containing a liquid to transfer heat. As the liquid evaporates, it carries heat to the cool end, where it condenses and then runs back to the hot end. Heatpipes have a much higher thermal conductivity than solid materials. Please keep the vent holes clear.



4K Display support The XH510G features one HDMI and one DisplayPort video output for 4K (3840 x 2160 / 2160p) high resolution at 60 Hz frames per second. Note: HDMI supports UHD at max. 30Hz with Comet Lake Prozessors.







ture range and 24/7 operation The Shuttle XPC slim Barebone XH510G is officially approved for 24/7 permanent operation. Thanks to its efficient cooling, this PC runs highly reliable making it perfectly suitable for digital signage and POI/POS applications - even at ambient temperatures of up to 50 °C (non-condensing). **Caution:** For high ambient temperatures over 40 °C we strongly recommend to use SSDs.

Supports extended tempera-

Two M.2-Slots for SSD cards XH510G even offers two M.2-2280M slots for M.2 SSD flash memory cards – both support SATA and one also supports NVMe/PCIe. Type 2280 means, it supports the usual M.2 cards with a width of 22 mm and a length of 80 mm, but also 2242 and 2260 standard cards are supported.

Power on after Power fail The BIOS setup provides a "Power-On after Power Fail" function that can be found under "Power Management Configuration". As the name indicates, this function determines the PC's behaviour after power failure: (1) unconditional power on, (2) restore former status (3), keep system turned off (4), Power-On by LAN or (5) Power-On by Real-Time-Clock. As a matter of the nature of this function, it may fail after short power failures. This is why the XH510G also comes with a hardware-based solution. By removing Jumper JP1, the system will start unconditionally once power is applied.

External power button by separate remote line

If, because of space constraints (e.g. in case of fixed installation), the machine cannot be switched on by pressing the front power button, it can be powered on by a separate remote line. You will find an appropriate four-pin connector at the back panel of the XH510G (pitch 2.54 mm). Furthermore, this connector provides a Clear CMOS function and +5V DC voltage supply for external devices.

+5V voltage (2) Clear CMOS (1)

(4) Power Button (3) Ground

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PRODUCT SPECIFICATIONS

REQUIRED COMPONENTS

The following components need to be added to make it a fully-configured Mini PC



Bottom view:









LGA1200 Processor Intel Core Gen 10 "Comet Lake-S" or Gen 11 "Rocket Lake-S" Core i9 / i7 / i5 / i3, Pentium Gold or Celeron TDP max. 65 W



Up to two M.2 SSDs Supports one M.2-2280/2260/2242 SSD card with SATA or PCle/NVMe interface Supports a <u>second M.2-2280 SSD card</u> with SATA



PCI-Express Card (optional) e.g. Single Slot Graphics Card, PCIe X16, max. 75 W TDP Dimensions: max. 208 mm x 120 mm x 30 mm



2.5" Storage Drive SATA hard disk or Solid State Disk (SSD) (max. height: 9.5 mm)



Operating System Windows 10/11 or Linux (64-bit only)

OPTIONAL ACCESSORIES FROM SHUTTLE





COM-Port-Adapter PCP11 To add a COM-Port (RS232) in the back panel. This accessory cannot be used in combination with PVG01.

VGA port adapter PVGO1 To add an analog D-Sub/VGA-Port in the back panel. This accessory cannot be used in combination with PCP11.





WLAN-Accessory WLN-M / WLN-M1 M.2-2230 card supports WLAN and Bluetooth including 2 antennas

Cable CXP01 Cable for external push button switch (without button)

EXAMPLES WITH EXPANSION CARDS



Despite its compact dimensions, the Shuttle XPC slim Barebone XH510G sports a full-size PCI-Express-X16 slot for single-slot cards not exceeding 208 mm (length), 120 mm (height) and 30 mm (width) and max. 75 W power consumption. At the same time, other powerful PC components such as an Intel Core i9 processor or 64 GB RAM are supported. This makes it particularly versatile in use which often asked for a bigger PC in the past.

Including 4-pin Molex connector with 5V/2A auxiliary voltage for special expansion card:



Shuttle XPC slim Barebone XH510G with powerful graphics card installed

EXPANSION CARD

Standard Graphics Card (Single Slot) e.g. Gigabyte GT-1030

Multi-port Graphics Card e.g. AMD FirePro W600 or Matrox C680 with 6x Mini-DisplayPort

CAD Graphics Card e.g. NVIDIA Quadro P2200

Video Capture Card e.g. with 4x SDI/BNC

Receiver Card

e.g. for SAT, DVB-T2, Cable

Special Network Card e.g. Multiport or 10 Gbps

Fieldbus Card e.g. EtherCAT, Profibus, CAN, Modbus, etc.

Multi I/O Card e.g. 8x COM-Port, DA/AD converter, generalpurpose input/output (GPIO) POSSIBLE APPLICATIONS

- Desktop PC
- 3D Workstation
- Visualisation for Control Rooms
- Surveillance and Security
- Digital Signage with Video Wall
- Information Display (POI)
- CAD Applications
 - Content Creation
- 3D Workstation
- Multi-channel Capture System
- Proxy and Firewall Applications
- Intranet Server
- Industry Automation
- Conveyor Technology
- Building Automation
- Point of Sales (POS)
- Vending Machine
- Automation / Control System
- Home Entertainment





Riser Card with PCI-Express X16 Slot

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PRODUCT SPECIFICATIONS

Front and Back Panel

Front Panel





- 1. 2x USB 2.0 port
- 2. 2x USB 3.2 Gen 1 port (blue)
- 3. Microphone input
- 4. Headphones output
- 5. Power button with Power LED indicator
- 6. LED indicator for storage activity
- 7. 2x Thumbscrew
- 8. 2x WLAN perforation
- 9. Hole for Kensington Lock
- 10. PCI-Express X16 expansion slot
- 11. Perforation for optional COM port
- 12. HDMI port
- 13. DisplayPort
- 14. RJ45 Gigabit LAN port
- 15. 2x USB 3.2 Gen 1 port (blue)
- 16. 2x USB 2.0 port
- 17. DC-in connector for power adapter
- 4-pin connector (2.54 mm pitch) for external power button, Clear CMOS button and 5V DC voltage





Bottom View

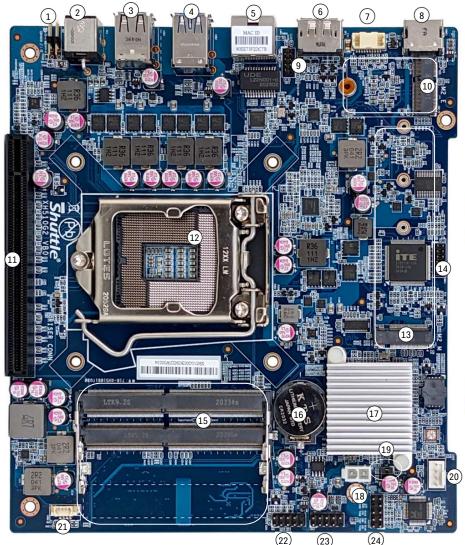


- 19. Installed heatpipe cooling system
- 20. 2x DIMM slot for DDR4 memory
- 21. M.2-2280 slot for one PCIe or SATA SSD module
- 22. M.2-2280 slot for one SATA SSD module
- 23. Storage bay for 2.5" drive with SATA port

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PRODUCT SPECIFICATIONS

Mainboard



Rear View



- 1. 4-pin connector (2.54 mm pitch) for external power button, Clear CMOS button and 5V DC voltage
- 2. DC-in connector for power adapter
- 3. 2x USB 2.0 port
- 4. 2x USB 3.2 Gen 1 port
- 5. RJ45 Gigabit LAN port
- 6. DisplayPort
- 7. Onboard VGA connector (analog)
- 8. HDMI port
- 9. Onboard COM port supports RS232
- 10. M.2-2230E slot for WLAN card
- 11. PCI-Express X16 slot for the built-in Riser Card
- 12. LGA1200 processor socket
- 13. M.2-2280M slot for SSD card

PCIe Riser Card (90° angle) with X16 slot



- - 14. Debug header (reserved)
 - 15. 2x SO-DIMM memory slot
 - 16. CMOS battery
 - 17. Intel H510 chipset with heat sink
 - 18. 5V power supply connector
 - 19. Always-Power-On jumper
 - 20. 4-pin connector for cooling fan
 - 21. 4-pin USB 2.0 connector
 - 22. Front panel power button and LED connector
 - 23. Front panel USB 2.0 connector
 - 24. Front panel Audio connector
 - 25. SATA v3.0 connector
 - 26. M.2-2280 slot for a SATA SSD module
 - 27. Front panel USB 3.0 connector

Shuttle Product Comparison: XH410G versus XH510G / XH510G2

MODEL	XH410G	XH510G	XH510G2				
Processor Support	10 th Gen. Intel Core Processors "Comet Lake-S" Socket LGA1200, TDP max. 65W	10 th / 11 th Gen. Intel Core Processors "Comet Lake-S" and <mark>"Rocket Lake-S"</mark> Socket LGA1200, TDP max. 65W					
OS Support	Windows 10 & Linux – 64-bit	Windows 10 & Linux – 64-bit					
Chipset	Intel H410	Intel H510					
Memory (max.)	2x 32 GB DDR4-2666/2933 SO-DIMM (260 pins)	2x 32 GB DDR4-2666/2933/3200 *) S0-DIMM (260 pins)					
Drive Bays	1x 2.5" bay (SATA v3.0) 1x 2.5" bay (SATA v3.0) Max. 9.5 mm height Max. 9.5 mm height						
PCI-Express Slot(s)	Single Slot: 1x PCI-Express v3.0 X16 Max. length/width: 208/30 mm Max. TDP: 75 W	Single Slot: 1x PCI-Express v3.0/v4.0 X16 Max. length/width: 208/30 mm Max. TDP: 75 W	Dual Slot: 1x PCI-Express v3.0/v4.0 X16 *) Max. length: 208 mm Max. TDP: 75 W 1x PCI-Express v3.0 X1				
M.2 Slots	M.2-2280M (for PCIe or SATA SSDs) M.2-2230E (for WLAN modules)	M.2-2280M (for P M.2-2280M (f M.2-2230E (for	or SATA SSDs)				
Front Panel Ports	2x USB 3.2 Gen 1 2x USB 2.0 2x Audio Power-Button Power-LED, HDD-LED	2x USB 3.2 Gen 1 2x USB 2.0 2x Audio Power-Button Power-LED, HDD-LED					
Back Panel Ports	HDMI 2.0a + D-Sub/VGA 2x USB 3.2 Gen 1 + 2x USB 2.0 Gigabit LAN Connector for ext. Power Button Optional RS232 COM port DC input	- 2x USB 2.0 2x USB 3.2 Gen 1 + 2x USB 2.0 AN Gigabit LAN Power Button Connector for ext. Power Button COM port Optional COM oder VGA port					
Internal Ports and Jumpers	USB 2.0 Type A (for USB stick) Always-power-on-Jumper 5V power output connector (2-pin)	Always-power-on-Jumper					
Power Adapter	180 W / 19.5 V	180 W ,	/ 19.5 V				
Optional Accessories	WLAN kit (WLN-M/-M1) Power Button cable (CXPO1) COM port adapter (PCP11) Vertical stand (PSO1)	WLAN kit (WLN-M/-M1) Power Button cable (CXP01) COM port adapter (PCP11) **) D-Sub/VGA port adapter(PVG01) **) Vertical stand (PS01)	WLAN kit (WLN-M/-M1) LTE/4G-Kit (WWN03) Power Button cable (CXP01) COM port adapter (PCP11) **) D-Sub/VGA port adapter(PVG01) **) Second power adapter: (PRC01 with PE90/PE180)				
Chassis Dimensions	25 x 20 x 7.85 cm (3.9 L)	25 x 20 x 7.85 cm (3.9 L)	25 x 20 x <mark>9.5</mark> cm (4.7 L)				
Front View	Shuttle	Shuttle	Shuttle				
Back View							

*) DDR4-3200, PCI-Express X16 v4 and HDMI 2.0a is only supported with Gen 11 "Rocket Lake-S" Processor **) The Accessories CXP01 (COM port) and PVG01 (VGA port) cannot be used at the same time

SHUTTLE XPC SLIM BAREBONE XH510G - SPECIFICATIONS

CHASSIS	Slim X-type chassis, colour: black Dimensions: 250 x 200 x 78.5 mm (LWH), Volume: ca. 3.9 litres Weight: 1.9 kg net, 3.2 kg gross Open front - no concealed front panel connectors Hole for Kensington Lock at the backpanel
OPERATING POSITION	(1) horizontal on its feet(2) vertical with the supplied VESA mount bracket
POWER ADAPTER	External 180 W power adapter (fanless) Input: 100~240 V AC, 50~60 Hz, max. 2.5 A Output: 19.5 V DC, max. 9.23 A, max. 180 W output wattage AC Connector with protective-earth contacts, cable length: 1.7 m DC Connector: 5.5 / 2.5 mm (outer/inner diameter) Dimensions: ca. 167 x 82 x 25.5 mm = 350 ml
OPERATING SYSTEM	This system comes without an operating system. It is compatible with Windows 10, Windows 11 and Linux (64-bit)
PROCESSOR SUPPORT	Processor Socket LGA1200 Supports Intel Core i9 / i7 / i5 / i3, Pentium Gold and Celeron processors Supports 10 th and 11 th generation Intel Core processors, codenamed "Comet Lake-S" and "Rocket Lake-S" in 14 nm process technology Maximum supported processor power consumption (TDP) = 65 W Up to 10 CPU cores, 20 threads and 20 MB of L3 cache Does not support the unlock-function of Intel K-Series processors. The processor integrates PCI-Express, RAM controller and the graphics engine (Performance features depend on processor type [6]) Please refer to the support list for detailed processor support information at global.shuttle.com. <u>Not compatible</u> with older Socket LGA 1151(v2) processors.
PROCESSOR COOLING	Processor cooling with heatpipe technology and two fans (60 mm)
MAINBOARD / CHIPSET	Mainboard in a Shuttle form factor proprietary design for the XPC XH510G Chipset/Southbridge: Intel® H510 Passive chipset cooling with heat sink The Northbridge is integrated in the processor. Solid Capacitors for sensitive areas provide excellent heat resistance for enhanced system durability
BIOS	AMI BIOS, SPI Interface, 16 MB Flash-EEPROM Supports Hardware Monitoring and Watchdog functionality Supports Firmware-TPM (fTPM) v2.0 [5] Supports boot up from external USB flash memory Supports Unified Extensible Firmware Interface (UEFI) Supports power on after power failure [1]
MEMORY SUPPORT	2x SO-DIMM slot with 260 pins The maximum DDR4 clock frequency depends on the processor type used: - Gen. 11 "Rocket Lake" supports DDR4-3200 (PC4-25600U) - Gen. 10 "Comet Lake" Core i7/i9 supports DDR4-2933 (PC4-23433U) - other Gen. 10 "Comet Lake" support DDR4-2666 (PC4-21300U) Supports Dual Channel mode Supports a maximum of 32 GB per DIMM, maximum total size: 64 GB Supports two unbuffered DIMM modules (no ECC or registered)
INTEGRATED GRAPHICS	The features of the integrated Intel UHD graphics function depend on the processor type used. [6] The PC features two video outputs: - HDMI v2.0a (only HDMI v1.4b with Gen. 10 "Comet Lake" processors) - DisplayPort v1.4 Both outputs support displays with 4K Ultra HD resolution at 3840 x 2160 with 60 Hz refresh rate (2160p60) and support multi-channel digital audio over the same cable (HDMI 1.4b support Ultra HD with 30 Hz only). Supports two independent displays with the integrated graphics function Optional analog D-Sub/VGA video output [4]



PCIE EXPANSION SLOT	The pre-installed 90° Riser Card provides one PCI-Express expansion slots: 1x PCI-Express X16 v4.0 slot (only PCIe v3.0 with Gen. 10 "Comet Lake" processors) Supports single-slot (single-width) graphics cards The used PCIe X16 expansion card must meet the following conditions: 1) Maximum dimensions: 208 mm x 120 mm x 30 mm 2) Maximum power consumption: 75 W For special purposes, the mainboard provides a 5V auxiliary voltage (max. 2 A) via 4-pin Molex connector.
AUDIO	Audio Realtek® ALC662/897/888 High-Definition Audio Two analog audio connectors (3.5 mm) at the front panel: (1) Microphone input (2) Headphones output (Line out) Digital 7.1 audio output: possible via the HDMI and DisplayPort connectors
GIGABIT LAN	Intel i219LM network controller Supports 10 / 100 / 1.000 MBit/s operation Supports WAKE ON LAN (WOL) Supports network boot by Preboot eXecution Environment (PXE)
2.5" STORAGE BAY	This system features one 2.5" drive bay which is accessible from the bottom of the housing. It supports one 2.5" / 6.35 cm hard disk or SSD with max. 9.5 mm height. The system includes a pre-installed data/power cable [3] . The connector supports SATA III with max. 6 Gbps.
TWO M.2 SLOTS FOR SSD CARDS	This system features two M.2-2280M slots. Both M.2 slots support M.2 cards with key M or key B+M. Both M.2 slots support SSD cards with SATA interface. One of the slots also supports SSDs with PCI Express interface and NVMe support. <u>M.2-Slot 1:</u> - is located inside the housing - supports M.2 cards with a length of 80, 60 or 80 mm (type 2242, 2260, 2280) - supports SATA v3.0 (6 Gbps) or PCIe v3.0 X4 (NVMe) <u>M.2-Slot 2:</u> - is accessible from the bottom of the housing - supports M.2 cards with a length of 80 mm (type 2280) - supports M.2 cards with a length of 80 mm (type 2280) - supports SATA v3.0 (6 Gbps)
M.2-2230E SLOT	The M.2 2230E slot has the following interfaces: - PCI-Express v2.0 X1 - USB 2.0 It supports M.2 cards with a width of 22 mm and a length of 30 mm. This slot is intended for Wireless LAN (Wifi) cards.
FRONT PANEL Connectors	1x Microphone input (3.5 mm) 1x Headphones output (3.5 mm, line out) 2x USB 3.2 Gen 1 (blue, max. 5 Gbps) 2x USB 2.0 1x Power button with Power LED (blue) 1x HDD LED (yellow)
BACK PANEL Connectors	1x HDMI 2.0a supports screw lock (supports only HDMI v1.4b with Gen. 10 "Comet Lake" processors) 1x DisplayPort 1.4 2x USB 3.2 Gen 1 (blue, max. 5 Gbps) 2x USB 2.0 1x GigaBit LAN (RJ45, Intel i219LM) 1x DC-input connector for external power adapter (supports 19.5 V) 1x 4-pin connector (2.54 mm pitch) supports: - external power on button - Clear CMOS function - +5V DC voltage for external components 1x perforation for optional VGA or COM port [4] 2x perforation for optional Wireless LAN antennas 1x hole for Kensington Lock



OTHER ONBOARD Connectors	 2-pin onboard ATX connector with 5V (max. 2 A) output voltage with 4-pin Molex adapter cable Power-on-after-power-fail (hardware solution by jumper) [1] RS232 COM port (2x5-pin header, 2 mm pitch) Analog VGA graphics output CN1 (2x 10-pin, 1 mm pitch) [4] Front connector for power button, LEDs, USBs, audio ports 4-pin fan connectors (occupied by the CPU cooling system) 4-pin USB 2.0 connector 2x 5-pin debug port
SUPPLIED ACCESSORIES	Multi-language installation guide (EN, DE, FR, ES, JP, KR, SC, TC) Driver DVD Bracket for one 2.5" drive Four screws M3 x 4 mm (to mount a 2.5" storage device into the bay/bracket) Three screws M2 x 5 mm (to mount the drive bracket) VESA mount brackets (2 parts, metal) supports 75x75 and 100x100 mm VESA standard Four screws M3 x 5 mm (screws together VESA mount and PC) Four screws M4 x 10 mm (to affix VESA mount on the PC) Three screws M3 x 5 mm (silver colour, to mount up to three M.2 cards) Internal adapter cable with 4-pin Molex connector for 5V/2A auxiliary voltage External power adapter with 1.7 m power cord with earthing contact Protector cap for the CPU socket (do not use if heat-pipe or fan is mounted) CPU heatpipe cooling system with heatsink compound
OPTIONAL Accessories	WLN-M: WLAN module supports WLAN and Bluetooth, with two external antennas PCP11: Backpanel COM port adapter for RS232 serial interface [4] PVG01: optional D-Sub VGA video output [4] CXP01: Adapter cable for external power button
ENVIRONMENTAL SPECIFICATIONS	Operating temperature range: 0~50 °C [2] Relative humidity range: 10~90 % (non-condensing)
CERTIFICATIONS / COMPLIANCE	 EMI: CE, FCC, BSMI, VCCI, RCM Safety: CB, cTUVus, BSMI Other: RoHS, Energy Star v8.0, ErP This device is classed as a technical information equipment (ITE) in class B and is intended for use in living room and office. The CE-mark approves the conformity by the EU directives: (1) 2004/108/EC relating to electromagnetic compatibility (EMC), (2) 2006/95/EC relating to Electrical Equipment designed for use within certain voltage limits (LVD), (3) 2009/125/EC relating to ecodesign requirements for energy-related products (ErP)

Footnotes:

[1] Power on after power fail

The BIOS setup provides a "Power-On after Power Fail" function that can be found under "Power Management Configuration". As the name indi-cates, this function determines the PC's behaviour after power failure: (1) unconditional power on, (2) restore former status or (3) keep system turned off. As a matter of the nature of this function, it may fail after short power failures. This is why the XH510G also comes with a hardware-based solution. By removing Jumper JP1 (located in a corner of the mainboard near the DIMM sockets) the system will start unconditionally once power is supplied.

[2] High ambient temperature

For high ambient temperature over 40 °C we strongly recommend to use SSDs instead of hard disk drives.

[3] Power connector for SATA drives

The supplied power cable for a SATA drive provides a voltage of 5 V. In very rare cases a 2.5" hard disk also requires a 12 V line. This is not supported. [4] Optional VGA or COM port

At the back panel is a perforation for optional installation of a D-Sub connection - either an analog VGA port (adapter PVGO1) or a serial RS232 port (adapter PCP11). The required adapter is not included in the scope of delivery and can be purchased as a Shuttle accessory item. Note: With the installation of a VGA connector, three monitor ports are available, but only two of them can be used simultaneously.

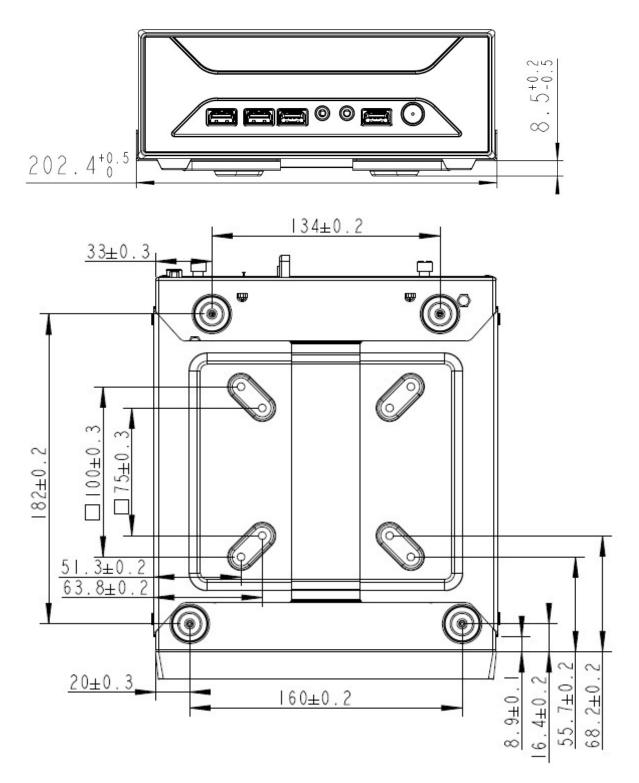
[5] TPM Function

This product features Firmware-TPM (fTPM) v2.0. Besides, it is prepared for a hardware TPM chip which can be fitted by factory on request.

[6] Intel processors without integrated graphics can be identified by their model name ending on "F", e.g. Core i7-10700E. When using this CPU, a graphics card is required.



XH510G drawing



10TH GENERATION INTEL CORE DESKTOP PROCESSOR FAMILY

Socket LGA1200 14 nm "Comet Lake S" and "Comet Lake Refresh" processor overview (Date: November 2021) Processors with a TDP of more than 65W are not supported (marked in red).

PROCESSOR	MODEL	CORES/ Threads	CPU Clock	TURBO BOOST Clock (2.0)	SMART Cache	TDP	Memory Support	GRAPHICS ENGINE
	10900K	10/20	3.7 GHz	5.1 GHz	20 MB	125 W	DDR4-2933	UHD 630 (1.2 GHz)
	10900KF	10/20	3.7 GHz	5.1 GHz	20 MB	125 W	DDR4-2933	None
Coroll iO	10900	10/20	2.8 GHz	5.0 GHz	20 MB	65 W	DDR4-2933	UHD 630 (1.2 GHz)
Core™ i9	10900F	10/20	2.8 GHz	5.0 GHz	20 MB	65 W	DDR4-2933	None
	10900T	10/20	1.9 GHz	4.5 GHz	20 MB	35 W	DDR4-2933	UHD 630 (1.2 GHz)
	10850K	10/20	3.6 GHz	5.0 GHz	20 MB	125 W	DDR4-2933	UHD 630 (1.2 GHz)
	10700K	8/16	3.8 GHz	5.0 GHz	16 MB	125 W	DDR4-2933	UHD 630 (1.2 GHz)
	10700KF	8/16	3.8 GHz	5.0 GHz	16 MB	125 W	DDR4-2933	None
Core™ i7	10700	8/16	2.9 GHz	4.7 GHz	16 MB	65 W	DDR4-2933	UHD 630 (1.2 GHz)
	10700F	8/16	2.9 GHz	4.7 GHz	16 MB	65 W	DDR4-2933	None
	10700T	8/16	2.0 GHz	4.4 GHz	16 MB	35 W	DDR4-2933	UHD 630 (1.2 GHz)
	10600K	6/12	4.1 GHz	4.8 GHz	12 MB	125 W	DDR4-2666	UHD 630 (1.2 GHz)
	10600KF	6/12	4.1 GHz	4.8 GHz	12 MB	125 W	DDR4-2666	None
	10600	6/12	3.3 GHz	4.8 GHz	12 MB	65 W	DDR4-2666	UHD 630 (1.2 GHz)
	10600T	6/12	2.4 GHz	4.0 GHz	12 MB	35 W	DDR4-2666	UHD 630 (1.2 GHz)
Core™ i5	10505	6/12	3.2 GHz	4.6 GHz	12 MB	65 W	DDR4-2666	UHD 630 (1.2 GHz)
	10500	6/12	3.1 GHz	4.5 GHz	12 MB	65 W	DDR4-2666	UHD 630 (1.15 GHz)
	10500T	6/12	2.3 GHz	3.8 GHz	12 MB	35 W	DDR4-2666	UHD 630 (1.1 GHz)
	10400	6/12	2.9 GHz	4.3 GHz	12 MB	65 W	DDR4-2666	UHD 630 (1.1 GHz)
	10400F	6/12	2.9 GHz	4.3 GHz	12 MB	65 W	DDR4-2666	None
	10400T	6/12	2.0 GHz	3.6 GHz	12 MB	35 W	DDR4-2666	UHD 630 (1.1 GHz)
	10325	4/8	3.9 GHz	4.7 GHz	8 MB	65 W	DDR4-2666	UHD 630 (1.15 GHz)
	10320	4/8	3.8 GHz	4.6 GHz	8 MB	65 W	DDR4-2666	UHD 630 (1.15 GHz)
	10305	4/8	3.8 GHz	4.5 GHz	8 MB	65 W	DDR4-2666	UHD 630 (1.15 GHz)
	10305T	4/8	3.8 GHz	4.5 GHz	8 MB	65 W	DDR4-2666	UHD 630 (1.1 GHz)
	10300	4/8	3.7 GHz	4.4 GHz	8 MB	65 W	DDR4-2666	UHD 630 (1.15 GHz)
Core™ i3	10300T	4/8	3.0 GHz	3.9 GHz	8 MB	35 W	DDR4-2666	UHD 630 (1.1 GHz)
	10105F	4/8	3.7 GHz	4.4 GHz	6 MB	65 W	DDR4-2666	None
	10105	4/8	3.7 GHz	4.4 GHz	6 MB	65 W	DDR4-2666	UHD 630 (1.1 GHz)
	10105T	4/8	3.0 GHz	3.9 GHz	6 MB	35 W	DDR4-2666	UHD 630 (1.1 GHz)
	10100	4/8	3.6 GHz	4.3 GHz	6 MB	65 W	DDR4-2666	UHD 630 (1.1 GHz)
	10100F	4/8	3.6 GHz	4.3 GHz	6 MB	65 W	DDR4-2666	None
	10100T	4/8	3.0 GHz	3.8 GHz	6 MB	35 W	DDR4-2666	UHD 630 (1.1 GHz)
	G6605	2/4	4.3 GHz	-	4 MB	58 W	DDR4-2666	UHD 630 (1.1 GHz)
Basetimes O	G6600	2/4	4.2 GHz	-	4 MB	58 W	DDR4-2666	UHD 630 (1.1 GHz)
	G6505	2/4	4.2 GHz	-	4 MB	58 W	DDR4-2666	UHD 630 (1.1 GHz)
	G6500	2/4	4.1 GHz	-	4 MB	58 W	DDR4-2666	UHD 630 (1.1 GHz)
Pentium® Gold	G6500T	2/4	3.5 GHz	-	4 MB	35 W	DDR4-2666	UHD 630 (1.05 GHz)
	G6405	2/4	4.1 GHz	-	4 MB	58 W	DDR4-2666	UHD 610 (1.05 GHz)
	G6405T	2/4	3.5 GHz	-	4 MB	35 W	DDR4-2666	UHD 610 (1.05 GHz)
	G6400	2/4	4.0 GHz	-	4 MB	58 W	DDR4-2666	UHD 610 (1.05 GHz)
	G6400T	2/4	3.4 GHz	-	4 MB	35 W	DDR4-2666	UHD 610 (1.05 GHz)

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PRODUCT SPECIFICATIONS

PROCESSOR	MODEL	CORES/ Threads	CPU Clock	TURBO BOOST Clock (2.0)	SMART Cache	TDP	MEMORY Support	GRAPHICS ENGINE
	G5925	2/2	3.6 GHz	-	4 MB	58 W	DDR4-2666	UHD 610 (1.05 GHz)
	G5920	2/2	3.5 GHz	-	2 MB	58 W	DDR4-2666	UHD 610 (1.05 GHz)
Celeron®	G5905	2/2	3.5 GHz	-	4 MB	58 W	DDR4-2666	UHD 610 (1.05 GHz)
Celeiun®	G5905T	2/2	3.3 GHz	-	4 MB	35 W	DDR4-2666	UHD 610 (1.05 GHz)
	G5900	2/2	3.4 GHz	-	2 MB	58 W	DDR4-2666	UHD 610 (1.05 GHz)
	G5900T	2/2	3.2 GHz	-	2 MB	35 W	DDR4-2666	UHD 610 (1.05 GHz)

K = unlocked, T = Power optimized lifestyle, F = without integrated graphics, TDP = Thermal Design Power (max. Power Consumption). Note: The Shuttle XPC slim Barebone XH510G does not support the Unlock-function of Intel K-Series processors. Intel processors without integrated graphics can be identified by their model name ending on "F". When using this CPU, a graphics card is required.

Please refer to the support list for detailed processor support information at global.shuttle.com.

11TH GENERATION INTEL CORE DESKTOP PROCESSOR FAMILY

Socket LGA1200 14 nm "Rocket Lake S" processor overview (Date: November 2021) Processors with a TDP of more than 65W are not supported (marked in red).

PROCESSOR	MODEL	CORES/ THREADS	CPU Clock	TURBO BOOST Clock (2.0)	SMART Cache	TDP	MEMORY Support	GRAPHICS ENGINE Max. Clock
	11900K	8/16	3.5 GHz	5.3 GHz	16 MB	125 W	DDR4-3200	UHD 750 (1.3 GHz)
	11900KF	8/16	3.5 GHz	5.3 GHz	16 MB	125 W	DDR4-3200	None
Core™ i9	11900	8/16	2.5 GHz	5.2 GHz	16 MB	65 W	DDR4-3200	UHD 750 (1.3 GHz)
	11900F	8/16	2.5 GHz	5.2 GHz	16 MB	65 W	DDR4-3200	None
	11900T	8/16	1.5 GHz	4.9 GHz	16 MB	35 W	DDR4-3200	UHD 750 (1.3 GHz)
	11700K	8/16	3.6 GHz	5.0 GHz	16 MB	125 W	DDR4-3200	UHD 750 (1.3 GHz)
	11700KF	8/16	3.6 GHz	5.0 GHz	16 MB	125 W	DDR4-3200	None
Core™ i7	11700	8/16	2.5 GHz	4.9 GHz	16 MB	65 W	DDR4-3200	UHD 750 (1.3 GHz)
	11700F	8/16	2.5 GHz	4.9 GHz	16 MB	65 W	DDR4-3200	None
	11700T	8/16	1.4 GHz	4.6 GHz	16 MB	35 W	DDR4-3200	UHD 750 (1.3 GHz)
	11600K	6/12	3.9 GHz	4.9 GHz	12 MB	125 W	DDR4-3200	UHD 750 (1.3 GHz)
	11600KF	6/12	3.9 GHz	4.9 GHz	12 MB	125 W	DDR4-3200	None
	11600	6/12	2.8 GHz	4.8 GHz	12 MB	65 W	DDR4-3200	UHD 750 (1.3 GHz)
	11600T	6/12	1.7 GHz	4.1 GHz	12 MB	35 W	DDR4-3200	UHD 750 (1.3 GHz)
Core™ i5	11500K	6/12	3,9 GHz	4.9 GHz	12 MB	95 W	DDR4-3200	UHD 750 (1.3 GHz)
	11500	6/12	2.7 GHz	4.6 GHz	12 MB	65 W	DDR4-3200	UHD 750 (1.3 GHz)
	11500T	6/12	1.5 GHz	3.9 GHz	12 MB	35 W	DDR4-3200	UHD 750 (1.2 GHz)
	11400	6/12	2.6 GHz	4.4 GHz	12 MB	65 W	DDR4-3200	UHD 730 (1.3 GHz)
	11400F	6/12	2.6 GHz	4.4 GHz	12 MB	65 W	DDR4-3200	None
	11400T	6/12	1.3 GHz	3.7 GHz	12 MB	35 W	DDR4-3200	UHD 730 (1.2 GHz)

K = unlocked, T = Power optimized lifestyle, F = without integrated graphics, TDP = Thermal Design Power (max. Power Consumption). Note: The Shuttle XPC slim Barebone XH510G does not support the Unlock-function of Intel K-Series processors.

Intel processors without integrated graphics can be identified by their model name ending on "F". When using this CPU, a graphics card is required. Please refer to the support list for detailed processor support information at global.shuttle.com.

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